**IECQ-CECC** 

COMPONENT

QC 88000-C001

**ISSUE 2** 

### **SPECIFICATION**

**March 2007** 

### Component Specification For Ceramic Hermetically Sealed Transistor Optocouplers



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### IEC

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#### Box 131, rue de Varembé, CH 1211 Geneva 20, Switzerland

For sales enquiries, or further information, please contact our sales office at: Isocom Ltd, Hutton Close, Crowther Industrial Estate, District 3, Washington, NE38 0AH Tel: +44 0191 4166 546 Fax: +44 0191 4155 055

#### FOREWORD

The IECQ Quality Assessment System for Electronic Components (IECQ) is composed of those member countries of the International Electrotechnical Commission (IEC) who wish to take part in a harmonized system for electronic components of assessed quality. IECQ is also known in some European member countries as IECQ-CECC.

The object of the System is to facilitate international trade by the harmonization of the specifications and quality assessment procedures for electronic components, and by the grant of an internationally recognised Mark, or Certificate of Conformity. The components produced or services provided under the system are thereby acceptable in all member countries without further testing.

This Component Specification is based upon the requirements of IEC Publication QC 001002-2, and has been prepared by:

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and published under the authority of:

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#### AMENDMENT RECORD

No previous issue.

#### REQUIREMENTS

The requirements for IECQ-CECC Component Specifications as detailed in QC 001002-2 Amendment 1 clause 5.4 are satisfied by the following data sheet.

It should note that IECQ-CECC are not responsible for manufacturers declarations made in data sheets which fall outside the limits of approved detailed in IECQ-CECC certificates.

This Component Specification is intended for use with applicable IECQ-CECC Assessment Specifications. Eg: QC 88000-A0001

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## **ISOCOM®**LTD

## **Ceramic Hermetically Sealed Transistor Optocouplers**

- 4N24
- CD500/501 CSM200
- CH300
- CS200/201
- CS224
- **Features**
- Release to IECQ-CECC
- Hermetically Sealed
- High Density Packaging
- 1500V DC withstand Test Voltage
- Low Input Requirements
- High Current Transfer Ratio

- CSM165
- CSM1200
- CSM1224
  - **Applications**
  - Military, high reliability system
  - Medical instruments
  - Mos, Cmos Applications
  - Logic Interfacing
  - Data Transmission
  - Power Supply
  - Modems

### Description

These devices are single, dual and quad, hermetically sealed optocouplers. Each channel is composed of a Gallium Arsenide infra-red emitting diode and a silicon phototransistor. Package styles for these devices include 6 pin, 8 pin, 16 pin flat pack, and hybrid 4 pin, with surface mount, butt cut and gull wing options available.

The same electrical die, assembly processes and materials are used for each channel of each device shown below. Therefore absolute maximum ratings, recommended operating conditions, electrical specifications and performance characteristics are identical for all units. Any exceptions, due to packaging variations and limitations, are as noted.

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## Selection Guide Package Styles and Configuration Options

Package	6 pin DIP	6 pin DIP	6 pin LCC	8 pin DIP	16 pin Flat Pack	6 pin Metal Can TO-5		
Lead Style								
Channels	1	1	2	2	4	1		
Common Channel Wiring								
Isocom Part Numbers and Options								
Commercial	CS200/201	CS224 CS200	CSM200 CSM1200/1244	CD500 CD501	CSM165	4N24		
Defense Screen Level	CM200/201/L2	CS224 CS200/L2	CSM200/L2 CSM1200/1244/L2	CD500/L2 CD501/L2	CSM165/L2	4N24/L2		
Space Screen Level	CS200/201/L2S	CS224 CS200/L2S	CSM200/L2S CSM1200/1244/L2S	CD500/L2S CD501/L2S	CSM165/L2S	4N24/L2S		
Standard Gold Plate Finish	Gold Plate	Gold Plate	Gold Plate	Gold Plate	Gold Plate	Gold Plate		
Solder Dipped	Option 20	Option 20	Option 20	Option 20				
Butt Cut/Gold Plate	Option 10	Option 10	Option 10	Option 10				
Gull Wing/Solered	Option 30	Option 30	Option 30	Option 30				
Crew Cut/Gold Plate	Option 60	Option 60	Option 60	Option 60				

## **Functional Diagrams**

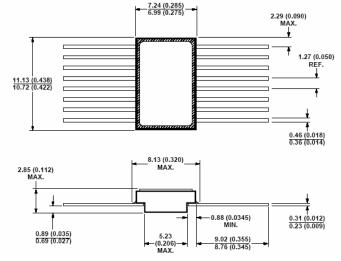
CH300 CSM200	CS200/201 CSM1200	CS224 CSM1224	CD500 CD501	CSM165/2/4
	6 pin DIP	6 pin DIP	8 pin DIP	16 pin Flat Pack
1 Channel	1 Channel	1 Channel	2 Channel	2*/4 Channel
43 文 12			8765 <u></u>	16 15 14 13 12 11 10 9 水 水 大 水
4N24				
6 pin TO-5				
1 Channel				

\* Note 2 channel is only for circuit of 2 middle channels 2 & 3 channel on the circuits.

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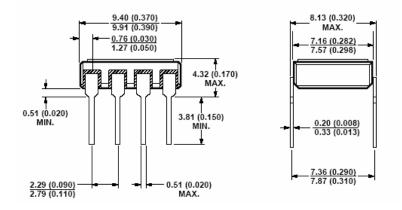
### **Outline Drawings**

#### 16 pin Flat Pack, 4 Channel

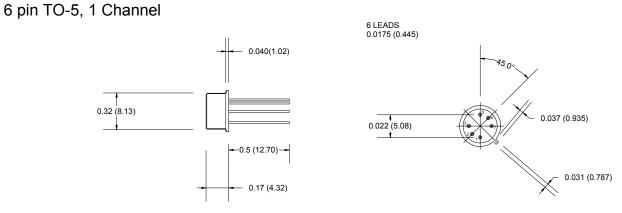


NOTE: DIMENSIONS IN MILLIMETERS

#### 8 pin DIP 2 Channel

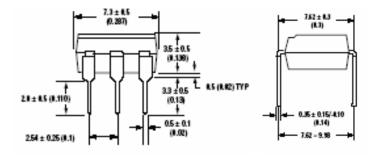


#### NOTE: DIMENSIONS IN MILLIMETERS



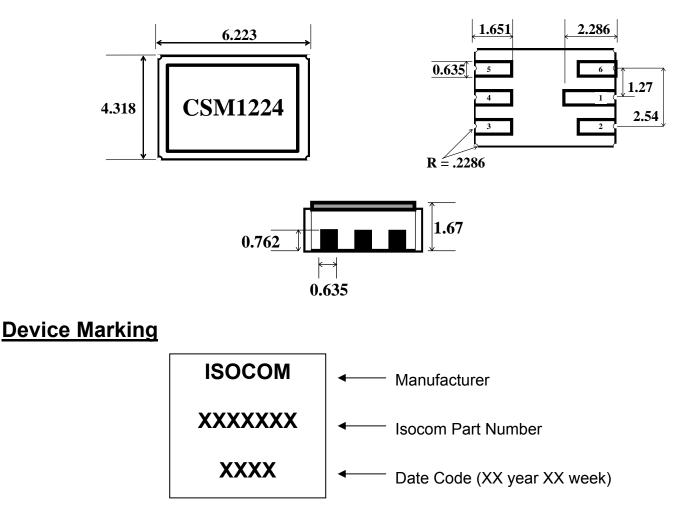
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#### 6 pin DIP 1 channel



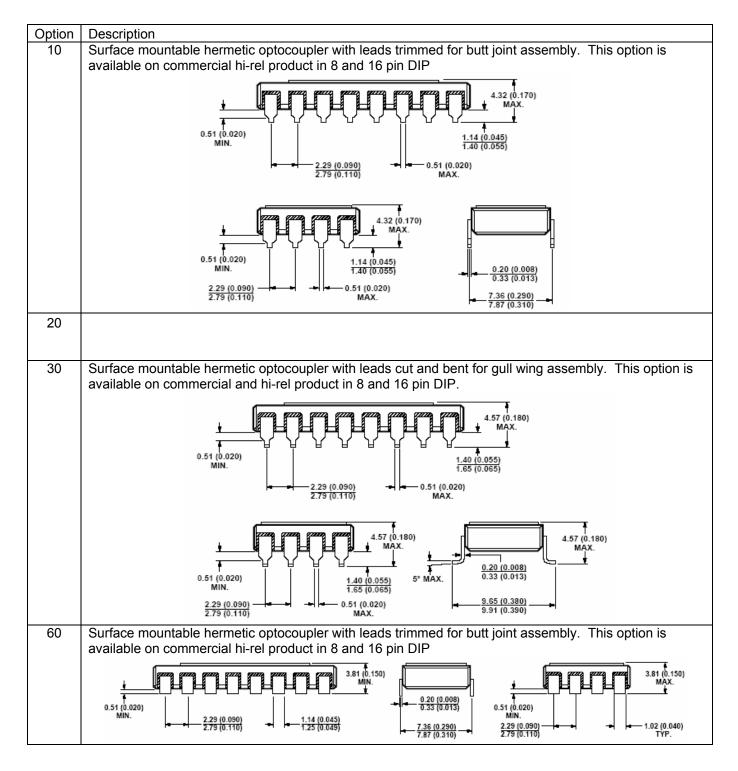
#### NOTE: DIMENSIONS IN MILLIMETERS

#### 6 Terminal LCC Surface Mount, 1 Channel



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## Hermetic Optocoupler Options



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## **Absolute Maximum Ratings**

Storage Temperature	-65°C to +150°C
Operating Temperature	-55°C to +125°C
Lead Soldering Temperature	260°C 1.6mm from case for 10S
Input-to-Output Isolation Voltage	<b>1500VDC</b>

### **Input Diode**

Forward DC Current	50mA	
	15mA	For CH300
Reverse DC Voltage	7V	
	5V	For CH300
	3V	For CSM165
	2V	For CS224
Peak forward Current	1.5mA	$\leq$ 10µS duration
Power Dissipation	100mW	Derate linearly above 100°C at 1.6W/°C.
	150mW	For CD500/501 andCSM165. Derate linearly above 100°C at 1.4W/°C for CD500/501, and at 1.6 W/°C for CSM165
	25mW	For CH300

#### **Output Transistor**

Collector-Emitter Voltage	50V	BV <sub>CEO</sub>
	30V	For CH300
	35V	For CS224
Emitter-Collector Voltage	7V	BV <sub>ECO</sub>
Collector-Base Voltage	70V	BV <sub>CBO</sub> For CS200/201 and CS224
	35V	For CS224
Collector Current	50mA	
	20mA	For CH300
Collector Current	100mA	t = 1mS
Power Dissipation	100mW	For CH300. Derate linearly above 100°C at 1.4W/°C
-	150mW	For CS200/201, CS224, CD500/501 and CSM165.
		Derate linearly above 100°C at 1.4W/°C

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# **Electrical Characteristics** $T_A = 25^{\circ}C U.O.S.$ (each channel where appropriate).

#### Input Diode Electrical Characteristics

Parameter		Symbol	Test Conditions	Device	Min	Туре	Max	Units
Forward Voltage		V <sub>F</sub>	I <sub>F</sub> = 10mA		0.7	1.18	1.6	V
			I <sub>F</sub> = 10mA, T <sub>A</sub> = 125°C		0.7	1.10	1.6	
			I <sub>F</sub> = 10mA, T <sub>A</sub> = -55°C		0.7	1.29	1.6	
Reverse Bre	eakdown	V <sub>R</sub>	I <sub>R</sub> = 0.1mA		5	-	-	V
Voltage								
Reverse Current		I <sub>R</sub>	V <sub>R</sub> = 3V		-	-	100	μA
Capacitance		CIN	V = 0, f = 1MHz		-	25	-	pF
<b>Output Detect</b>	or Elec	trical Ch	aracteristics					
Collector-Emitter		BVCEO	Ic = 1mA		40	-	-	V
Breakdown Voltage		020		CH300	30			
(See note 1 below)								
Collector-Base Brea	kdown	BV <sub>CBO</sub>	I <sub>B</sub> = 0.1mA		70	-	-	V
Voltage								
(See note 1 below)								
Emitter-Collector		BV <sub>ECO</sub>	$I_E = 0.1 \text{mA}$		7	-	-	V
Breakdown Voltage								
Emitter-Base Break	down	BV <sub>EBO</sub>	$I_B = 0.1 \text{mA}$		5	-	-	V
Voltage								
Collector-Emitter Le	akage	I <sub>CEO</sub>	$V_{CE} = 20V, I_F = 0$		-	6	100	μA
Current			$V_{CE} = 15 v I_F = 0$	CSM165				
			V <sub>CE</sub> = 20V, I <sub>F</sub> = 0, T <sub>A</sub> = 125°C		-	8	100	μA
<b>Coupled Elect</b>	rical Cl	haracter	istics					
DC Current Transfer	r Ratio	IC/IF	I <sub>F</sub> = 10mA, V <sub>CE</sub> = 5V		50	-	-	%
			CS201	100				
(See note 3)		I <sub>F</sub> = 10mA, V <sub>CE</sub> = 5V, T <sub>A</sub> = 125°C	CS201	50	-	-		
		I <sub>F</sub> = 10mA, V <sub>CE</sub> = 5V, T <sub>A</sub> = -55°C	CS201	50	-	-		
		I <sub>F</sub> = 10mA, V <sub>CE</sub> = 5V; T <sub>A</sub> = -55°C-125°C		35	-	-		
Optical Crosstalk		I <sub>CEOX</sub>	V <sub>CE</sub> = 15v, , I <sub>F</sub> 2-4 = 10mA.	CSM165			250	μA V
Collector-Emitter Sa	turation	V <sub>CE</sub>	$I_{\rm F}$ = 10mA, $I_{\rm C}$ = 2.5mA		-	-	0.3	V
Voltage		(Sat)						
-			$I_{\rm F}$ = 10mA, $I_{\rm C}$ = 10A	CSM165			0.9	
		$I_{\rm F} = 2mA, I_{\rm C} = 0.2mA$	CH300			0.25		
Input to Output Capa	acitance	CIO	$V_{IO}$ = 0, f = 1mhz (See note 2 below)		-	3	5	pF

#### Notes:

Input to Output Resistance

**Isolation Voltage** 

**Delay Time** 

Storage Time

Turn -on Time

Turn-off Time

**Rise Time** 

Fall Time

1. BV<sub>CEO</sub> and BV<sub>CBO</sub> can be selected to suit customer specifications.

R<sub>IO</sub>

VIO

td

tr

ts

tf

ton

t<sub>off</sub>

2. Measured between input when leads 1, 2 and 3 are shorted together and output when leads 4, 5 and 6 are shorted together.

V<sub>IO</sub> = 500V (See note 2 below)

(See note 2 below)

 $V_{CC} = 5V, I_C = 2mA$ 

 $V_{CC}$  = 5V, I<sub>f</sub> = 5mA

 $R_L = 1000$  hms

R<sub>L</sub> = 1KOhms

3. A higher CTR can be selected to suit customer specification as a standard part.

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Ω

VDC

μS

μS

μS

μS

μS

μS

10<sup>1</sup>

4.0

5.0

0.7

5.0

9

25

\_

\_

1500

500

-

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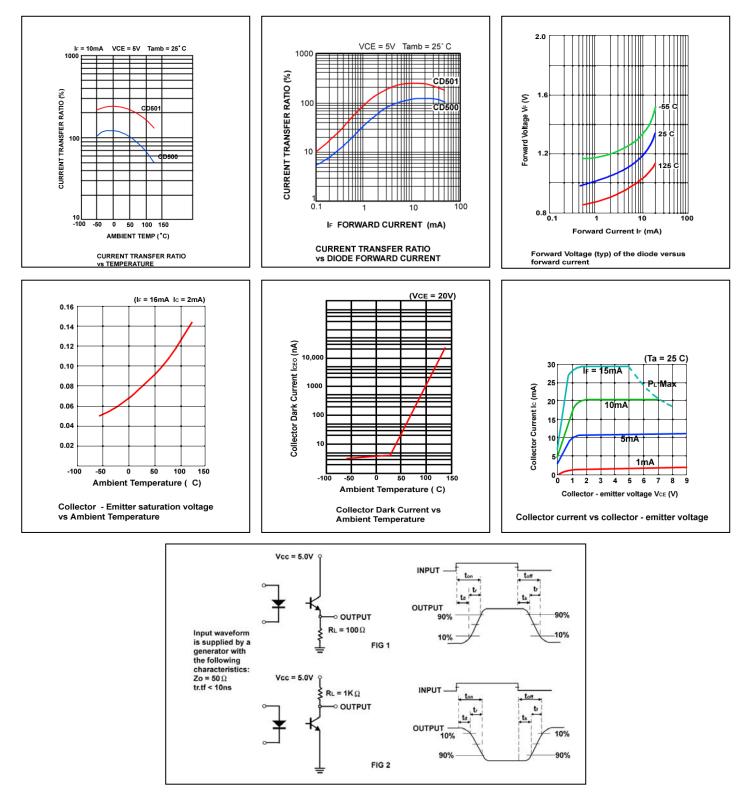
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CH300

### **Electrical Characteristics**



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